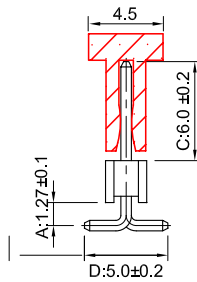
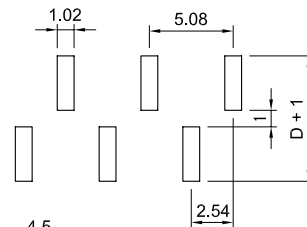
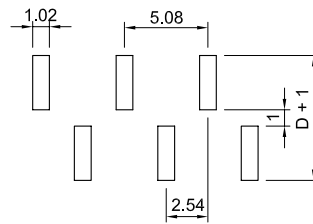
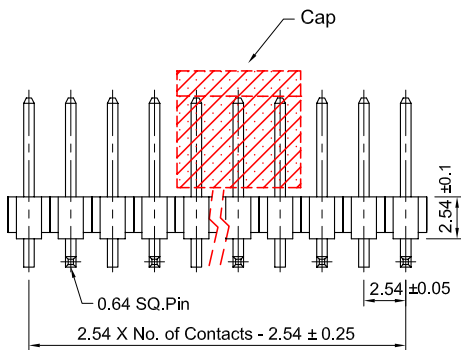
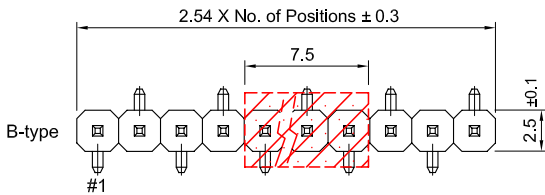
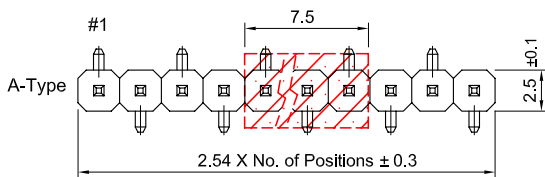


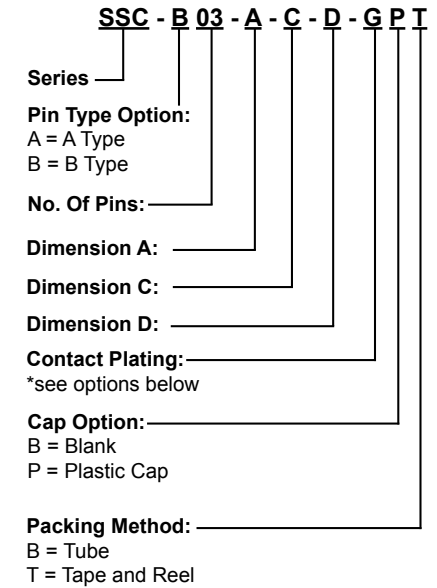
Recommended P.C. Board SMD Layout



Specifications

- Current Rating: 3 Amps
- Insulator Resistance: 1000Megohms min.
- Contact Resistance: 20 m ohms max.
- Dielectric Withstanding: AC 600V
- Operating Temperature: -40°C ~ +105°C
- Contact Material: Brass
- Insulator Material: Polyester, UL 94V-0 Nylon-6T
- Contact Plated: *see options below
- Standard: Full Gold Flash

Part Numbering System



* 3 Pins, B Type Example: **SSC-B03-1.27-6.0-5.0-GPT**
A = 1.27mm, C = 6.0mm, D = 5.0mm

General Tolerance	
X. ± 0.50	X.' ± 5°
.X ± 0.20	.X' ± 2°
.XX ± 0.10	.XX' ± 1°
Units : mm	

* Contact Plating Option	Full Gold Plating	Gold Plated On Contact Area Tin Plated on Solder Area	Full Tin Plating
	G : Gold Flash G10: Gold 10u" G15: Gold 15u" G30: Gold 30u"	S: Gold Flash S10: Gold 10u" S15: Gold 15u" S30: Gold 30u"	T: Tin 100u"